

Features

- 3727 with integrated high quality constant current IC and RGB LED chip.
- Built-in IC, with high precision of constant current and internal RGB chips spectral processing in advance.
- Single line data transmission (return to zero code).
- Specific Shaping Transmit Technology number of LED stacked is not restricted.
- Cascading Enhancement Technology any 2 LED spacing can be up to 10 meters
- Data transfer rate of 800 kbp/s at 30 frames per second.
- RGB output port PWM control can achieve 256 grey level adjustments.
- Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
- SA-I Anti-interference patent technology for single line data transmission.
- Built-in power supply reverse connect protection module, reversed power input will not damage the IC.

Description

The IN-PI3727TBTPRPGPB is 3.7*2.7*1.3mm RGB LED with integrated IC. It is a SMD type LED which can be used in various applications.

Applications

- Full color LED string light
- LED full color module
- LED guardrail tube
- LED scene lighting
- LED point light
- LED pixel screen
- LED shaped screen

Package Outline Dimensions & Pin Configuration

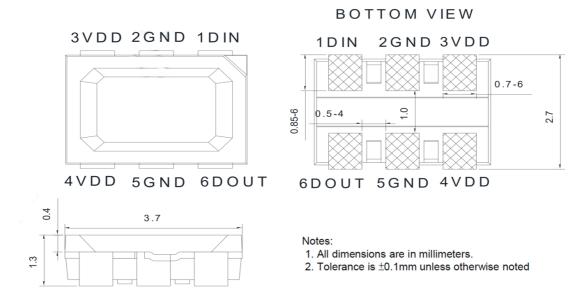


Figure 1. IN-PI3727TBTPRPGPB Package Outline Dimensions



Pin Configuration

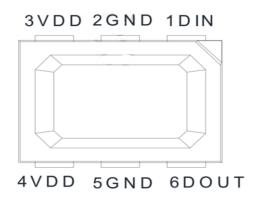


Figure 2. IN-PI3727TBTPRPGPB Pin Configuration

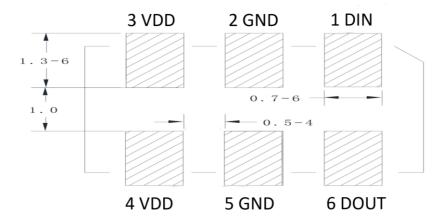
Notes:

1. Dimension in millimeter, tolerance is ± 0.1 mm unless otherwise noted.

Number	Symbol	Function Description			
1	DIN	Control data signal input			
2	GND Ground				
3	VDD	Power Supply LED			
4	VDD	Power supply LED			
5	GND	Ground			
6	DOUT	Control data signal output			

Soldering Pad Size

TOP VIEW





Absolute Maximum Rating (Ta = 25 C, VSS=0V)

Parameter	Symbol	Range	Unit
Logic supply voltage	Vod	+3.7~+5.5	V
Logic input voltage	VIN	-0.5 ~VDD+0.5	V
Operating temperature	Торт	−45 ~ + 85	°C
Storage temperature	Тѕтв	-45 ~ + 85	°C
ESD pressure(HBM)	Vesd	2K	V
ESD pressure(DM)	Vesd	200	V

LED Characteristics (Ta = 25°C)

Light color	Wavelength (nm)	Light intensity (mcd)	Working current (mA)
R	620-630	240-450	12
G	515-525	580-1050	12
В	460-470	120-240	12



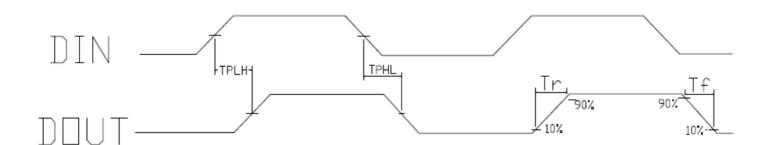
Recommended Operating Ranges (unless otherwise specified, TA=25 °C, VDD=4.5 ~ 5.5V, VSS=0V)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
Supply voltage	V_{DD}	1	5.2	1	V	-
High level input voltage	V _{IH}	0.7*VDD	1		V	VDD=5.0V
Low level input voltage	V _{IL}	-	-	0.3*VDD	V	VDD=5.0V
The frequency of PWM	F _{PWM}	-	4.0	-	KHZ	-
Static power consumption	I _{DD}	-	0.3	-	mA	-



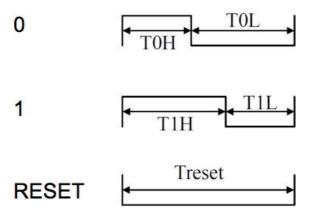
Switching Characteristics (unless otherwise specified, TA=25 °C)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
The speed of data transmission	fDIN	-	800	1100	KHZ	The duty ratio of 67% (data 1)
DOLIT transmission delay	T_{PLH}	-	-	500	ns	DIN→DOUT
DOUT transmission delay	T_{PHL}	-	-	500	ns	וטטט⊸אווט
L Pice/Drep Time	Tr	-	100	-	ns	VDS=1.5
I _{OUT} Rise/Drop Time	T_f	-	100	-	ns	I _{ουτ} =12mA



Timing Waveforms

1. Input Code





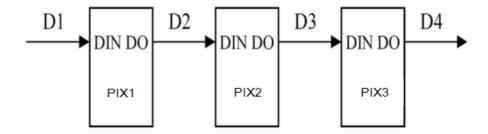
2. The data transmission time

	Name	Min.	Standard value	Max.	Unit
T	Code period	1.20	-	1	μs
ТОН	0 code, high level time	0.20	0.30	0.40	μѕ
TOL	0 code, low level time	0.80		1	μs
Т1Н	1 code, high level time	0.65	0.75	1.00	μs
T1L	1 code, low level time	0.20			μs
Trst	Reset code, low level time	>80			μs

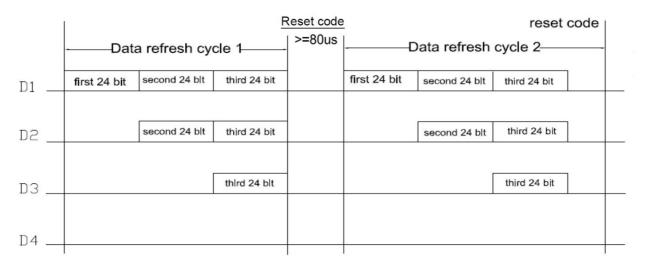
Notes:

- 1. The protocol uses a unipolar zeroing code. Each symbol must have a low level. Each symbol in this protocol starts with a high level. The high time width determines the "0" or "1" code.
- 2. When writing programs, the minimum symbol period is 1.2µs.
- 3. The high time of "0" code and "1" code should be in accordance with the stipulated range in the above table. The low time requirement of "0" code and "1" code is less than 20µs.

3. Connection Scheme



4. Data Transfer Format



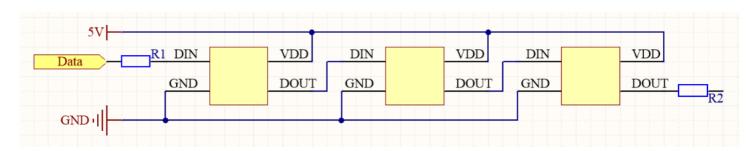
Note: the D1 sends data for MCU, D2, D3, D4 for data forwarding automatic shaping cascade circuit.

5. 24-bit data format

G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4
R3	R2	R1	RO	В7	В6	B5	B4	В3	B2	B1	ВО

Note: high starting, in order to send data (G7 - G6 -B0)

Typical Application Circuit



Note:

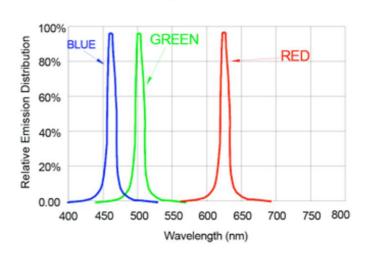
In the practical application circuit, the signal input and output pins of the IC signal input and output pins should be connected to the signal input and output terminals. In addition, to make the IC chip is more stable, even the capacitance between beads is essential back.

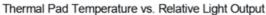
- 1. Application: used for soft lamp strip or hard light, lamp beads transmission distance is short, suggested in signal in time the clock line input and output end of each connected in series protection resistors, R1=R2 of about 500 ohms.
- Application: for module or general special-shaped products, lamp beads transmission distance is long, because of different wire and transmission distance, in the signal in time clock at both ends of the line on grounding protection resistance will be slightly different; to the actual use of fixed.

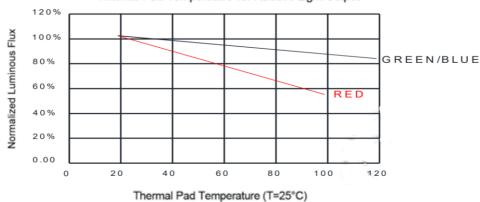


LED Performance Graph

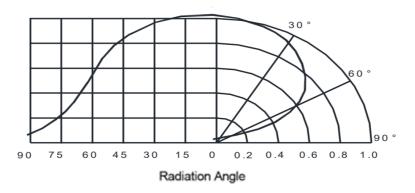
Wavelength Characteristics







Typical Radiation Pattern 120°

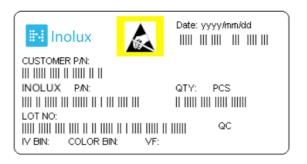




Ordering Information

Product	Emission Color	IV(mcd)	Orderable Part Number				
	R	240-450	IN-PI3727TBTPRPGPB				
IN-PI3727TBTPRPGPB	G	580-1050					
	В	120-240					

Label Specifications



Inolux P/N:

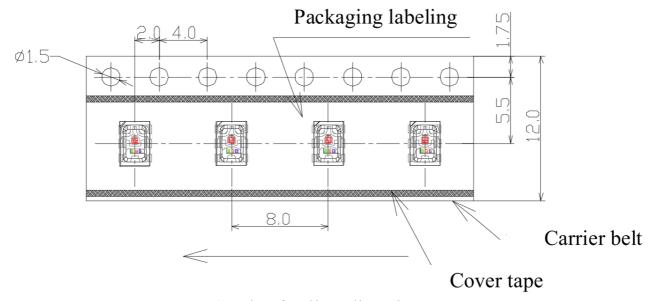
I	N	PI	ı	3727	Т	В	Т	Р	R	Р	G	Р	В	-		
		Product		Package	Die Qty.	Variation	Orientation	Current	Color	Current	Color	Current	Color		Custom Stamp	
Inol	ux	PI- Single trace IC PC- Clock Function IC		3727TB = 3	3.7 x 2.7 : pins)	x 1.3 mm (6	T = Top Mount	P=12mA	R = 625 nm	P=12mA	G = 520 nm	P=12mA	B = 465 nm			

Lot No.:

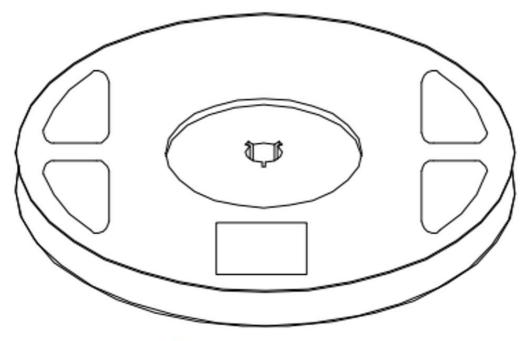
Z	2	0	1 7 01 24		24	001	
Internal		Voor (2017	2019 \		Month	Data	Serial
Tracker		Year (2017	, 2018,)		Month	Date	Seriai



Packaging



Carrier feeding direction



reel(178x12mm)



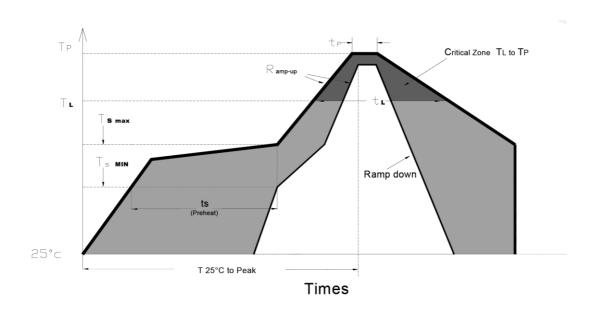
Precautions

Please read the following notes before using the product:

- 1. Storage
- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the LEDs should be kept at 30℃ or less and 80%RH or less.
- 1.3 The LEDs should be used within a year.
- 1.4 After opening the package, the remaining LEDs should be kept in a resealed bag.
- 1.5 The LEDs require mandatory baking before usage. Baking treatment listed below.
- 1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

^{*}Baking treatment: 60±5°C for24 hours.

2. Soldering Condition Recommended soldering conditions:



Profile Feature	Lead-Free Solder				
Average Ramp-Up Rate (Ts _{max} to Tp)	3°C/second max.				
Preheat: Temperature Min (Ts _{min})	150° C				
Preheat: Temperature Min (Ts _{max})	200 °C				
Preheat: Time (ts _{min to} ts _{max})	60-180 seconds				
Time Maintained Above: Temperature (T _L)	217 ℃				
Time Maintained Above: Time (t L)	60-150 seconds				
Peak/Classification Temperature (T P)	240 ℃				
Time Within 5°C of Actual Peak Temperature (tp)	<10 seconds				
Ramp-Down Rate	6°C/second max.				
Time 25 °C to Peak Temperature	<6 minutes max.				

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

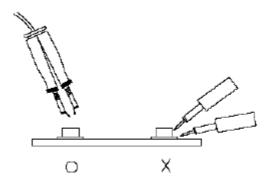


3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	10-05-2022
Add packaging information	10	1.1	06-28-2024

DISCLAIMER

INOLUX reserves the right to make changes without further notice to any products herein to improve reliability, function or design. INOLUX does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

LIFE SUPPORT POLICY

INOLUX's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of INOLUX or INOLUX CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.